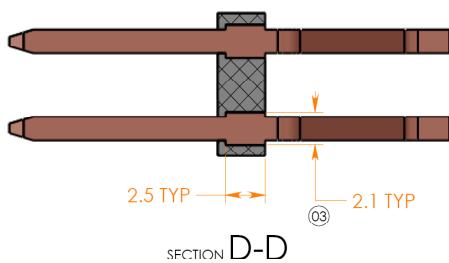
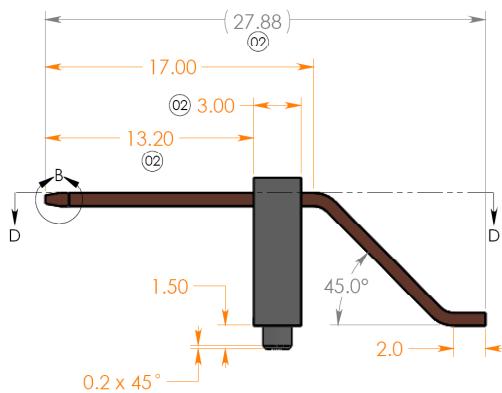
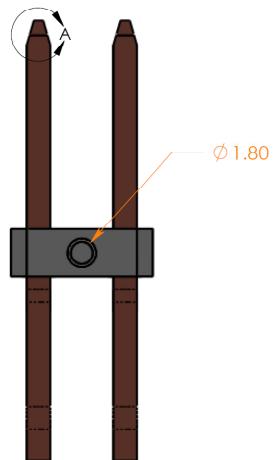
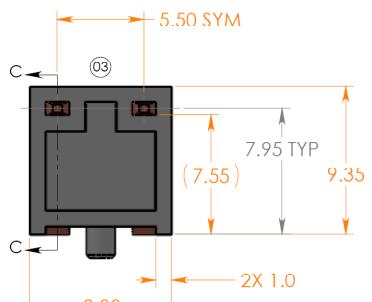
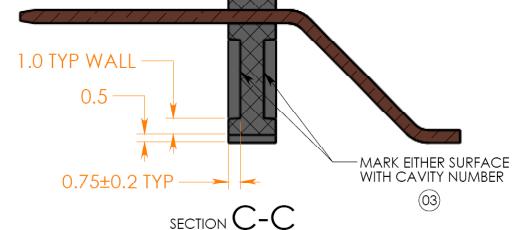
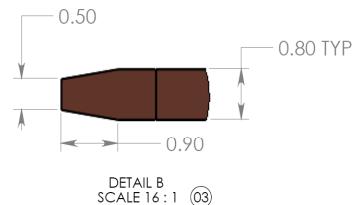


REVISIONS			
ZONE	REV.	DESCRIPTION	DATE
C3	02	INCREASED WAFER THICKNESS TO 3.0 mm	2013.02.18
D3	02	REDUCED TERMINAL OVERALL LENGTH	2013.02.18
D4	02	REDUCED TERMINAL MATE LENGTH	2013.02.18
D8	02	ADDED CENTER SLOT	2013.02.18
F1	03	ADDED DETAIL A FOR COINING INGO	2013.02.26
E7	03	ADDED DETAIL B FOR COINING INGO	2013.03.26
C7	03	ADDED CAVITY NUMBER REQUIREMENT	2013.02.26
D6	03	REMOVED CENTER SLOT	2013.02.26



NOTES:

1. MATERIAL
 - INSULATOR: LCP, UL94V-0, BLACK
- MASS: 0.23 g
 - TERMINAL: PHOSPHOR BRONZE
- MASS: 0.33 g EACH
2. PLATING
 - 0.8 - 2.0 µm Sn OVER 0.3 - 1.0 µm Ni

XX	XX	XX	APPROVALS	DATE
03	02	01	DRAWN BY C. Lee HOCHIEN INC	2013.01.14
NXXXX	NXXXX	NXXXX	SEE NOTES FINISH SEE NOTES	DIMENSIONS ARE IN MM UNLESS OTHERWISE SPECIFIED TOLERANCES ARE: XX-XX = ± 0.1 MM XX-XX = + 0.05 MM XX-XX = - 0.05 MM
19130126	19130118	19130114	PCRN BY CK	DO NOT SCALE PRINT THIRD ANGLE PROJECTION
SIZE:	C	REV./DATE:	PN#:	CM-B1010-0001
03	02	01	SHEET	REV. 03
SCALE:	4:1	1 OF 1	PART NO:	5892133
REF:			DRAWING NO:	589213303

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